



### APPLICATIONS

**FEATURES** 

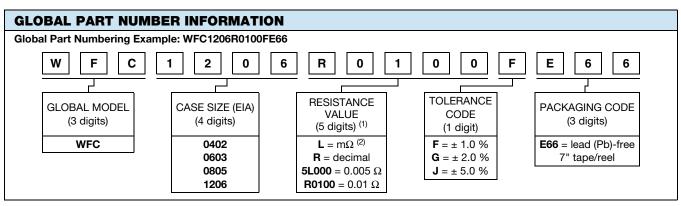
Switching power supply

· Ultra low sensing resistance

- Voltage regulation module
- DC/DC converter, adaptor, battery pack, charger
- Pad and cell phone
- Power management

STANDARD ELECTRICAL SPECIFICATIONS									
GLOBAL MODEL	SIZE	POWER RATING W	TOLERANCE %	$\begin{array}{c} \textbf{RESISTANCE}\\ \textbf{VALUE RANGE}\\ \Omega \end{array}$	WEIGHT (typical) g/1000 pieces				
WFC0402	0402	0.125	± 1, ± 2, ± 5	0.003 to 0.05	1.1				
WFC0603	0603	0.33	$\pm 1, \pm 2, \pm 5$	0.001 to 0.005	3.3				
	0603	0.25	$\pm 1, \pm 2, \pm 5$	0.0051 to 0.03	3.3				
WFC0805	0805	0.50	± 1, ± 2, ± 5	0.001 to 0.04	6.8				
WFC1206	1206	1.0	$\pm 1, \pm 2, \pm 5$	0.001 to 0.05	17.4				
	1206	0.5	$\pm 1, \pm 2, \pm 5$	0.100 to 0.18	17.4				

Low Value (Down to 0.001  $\Omega$ )



### Notes

(1) Resistance values are available per E12 and E24 decades; <u>www.vishay.com/doc?28372</u>

 $^{(2)}$  Use "L" for resistance values < 0.01  $\Omega$ 

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# WFC

COMPLIANT HALOGEN





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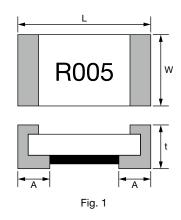
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**WFC** 

TECHNICAL SPECIFICATIONS								
PARAMETER	UNIT	RESISTOR CHARACTERISTICS						
FANAMETEN	UNIT	WFC0402	WFC0603	WFC0805	WFC1206			
	ppm/°C	$\pm$ 100 for 8 m $\Omega$ to 50 m $\Omega$	$\pm$ 75 for 10 m $\Omega$ to 30 m $\Omega$	± 50 for 10.1 mΩ to 40 mΩ	± 50 for 10.1 mΩ to 180 mΩ			
Temperature coefficient		$\pm$ 150 for 3 m $\Omega$ to 7 m $\Omega$	± 150 for 5.1 mΩ to 9 mΩ	± 100 for 1 mΩ to 10 mΩ	$\pm$ 100 for 1 m $\Omega$ to 10 m $\Omega$			
		-	± 100 for 1 mΩ to 5 mΩ	-	-			
Operating temperature range	°C	-55 to +170						
Maximum working voltage	V	$(P \times R)^{1/2}$						
Maximum element temperature	°C	170						

### **DIMENSIONS** in inches (millimeters)



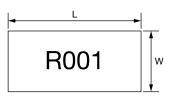




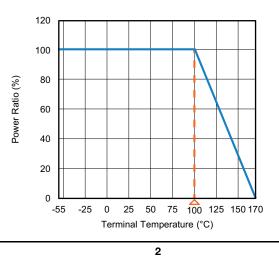
Fig. 2

TYPE	RESISTANCE		DIMENSIONS FIG.			
(INCH SIZE)	RANGE (mΩ)	L	L W t		Α	DIMENSIONS FIG.
WFC0402	7.1 to 50 1.00 $\pm$ 0.10 0.55 $\pm$ 0.10 0.45 $\pm$ 0.10		0.25 ± 0.10	1		
WFC0402	3 to 7	$1.00 \pm 0.10$	0.55 ± 0.10	$0.45 \pm 0.10$	0.35 ± 0.10	1
WFC0603	5.1 to 30	1.60 ± 0.10	0.80 ± 0.10	0.55 ± 0.15	$0.30 \pm 0.20$	1
	1 to 5	$1.00 \pm 0.10$	0.95 ± 0.25	0.60 ± 0.25	0.55 ± 0.20	2
WFC0805	5.1 to 40	$2.00 \pm 0.20$	1.30 ± 0.15	0.70 ± 0.15	0.45 ± 0.20	1
VIFC0005	1 to 5	2.10 ± 0.20	$1.40 \pm 0.20$	0.60 max.	$0.60 \pm 0.20$	2
WFC1206	1 to 3	3.10 ± 0.20	1.55 ± 0.20	0.75 ± 0.25	$1.30 \pm 0.20$	2
	3.1 to 180	5.10 ± 0.20	1.55 ± 0.20	0.80 ± 0.15	$0.55 \pm 0.20$	1

### Note

• 0402 has no marking; 0603, 0805, 1206 marking shows two digits for resistance

### DERATING



For technical questions, contact: ww2bresistors@vishay.com

Document Number: 30402

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### PERFORMANCES

ENV	ENVIRONMENTAL PERFORMANCE							
NO.	ITEM	TEST CONDITION	SPECIFICATION					
1	Short time overload	5 times rated power for 5 seconds (JIS-C5202-5.5)	$\Delta R: \pm (1 \% + 0.0005 \Omega)$					
2	Temperature coefficient of resistance (TCR)	+25 °C / +125 °C (JIS-C5202-5.2) TCR (ppm/°C) = $\frac{\Delta R}{R \times \Delta t} \times 10^{6}$	Refer to Electrical Specification					
3	Damp heat with load	The specimens shall be placed in a chamber and subjected to a relative humidity of 90 % to 95 % and a temperature of 40 °C $\pm$ 2 °C for the period of 1000 hours with applying rated power 1.5 hours ON and 0.5 hour OFF. (MIL-STD-202, method 103)	$\Delta R: \pm (1 \% + 0.0005 \Omega)$					
4	High temperature exposure	The chip (mounted on board) is exposed in the heat chamber 125 °C $\pm$ 3 °C for 1000 hours. (JIS-C5202-7.2)	$\Delta R: \pm (1 \% + 0.0005 \Omega)$					
5	Load life	Apply rated power at 70 °C $\pm$ 2 °C for 1000 hours with 1.5 hours ON and 0.5 hour OFF. (JIS-C5202-7.10)	$\Delta R: \pm (1 \% + 0.0005 \Omega)$					
6	Rapid change of temperature	The chip (mounted on board) is exposed, -55 °C $\pm$ 3 °C (30 min.) / +155 °C $\pm$ 2 °C (30 min.) for 5 cycles. The following conditions as the following figure. (JIS-C5202-7.4) Ambient temperature +155 ( $\pm$ 2) °C +25 ( $\pm$ 2) °C -55 ( $\pm$ 3) °C 1 cycle	Δ <i>R</i> : ± (1 % + 0.0005 Ω)					

FUNCTION PERFORMANCE							
NO.	ITEM	TEST CONDITION	SPECIFICATION				
1	Bending strength	Mount the chip to test substrate. Apply pressure in direction of arrow unit band width reaches 2 mm (+0.2 / -0 mm) illustrated in the figure below and hold for 10 s $\pm$ 1 s. (JIS-C5202-6.1) Position before bend Unit: mm Position before bend Amount of bend Testing printed circuit board	Δ <i>R</i> : ± (1 % + 0.0005 Ω)				
2	Solvent resistance	Complete immersion of specimens in isopropyl alcohol for 3 (+5, -0) min. 25 °C $\pm$ 5 °C. (MIL-STD-202, method 215)	Verify marking permanency. (not required for laser etched parts or parts with no marking)				
3	Resistance to solder heat	The specimen chip shall be immersed into the flux specified in the solder bath 260 °C $\pm$ 5 °C for 10 s $\pm$ 1 s. (MIL-STD-202, method 210)	Δ <i>R</i> : ± (1 % + 0.0005 Ω)				



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FUN	FUNCTION PERFORMANCE							
NO.	ITEM	TEST CONDITION	SPECIFICATION					
4	Solderability	The specimen chip shall be immersed into the flux specified in the solder bath 235 °C ± 5 °C for 2 s ± 0.5 s. It shall be immersed to a point 10 mm from its root. (Sn96.5 / Ag3.0 / Cu0.5) (JIS-C5 202-6.11) Molten solder Specimen SMD H = 10  mm H = 10  mm min.	Solder shall be covered 95 % or more of the electrode area.					

### Notes

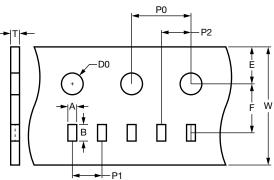
- 0.5 W with total solder pad trace size of 100 mm<sup>2</sup>. The surface temperature of component should below 100 °C ٠
- 1.0 W with total solder pad trace size of 100 mm<sup>2</sup>. The surface temperature of component should below 100 °C ٠

TAPE PACKAGING SPECIFICATIONS							
MODEL	REEL						
MODEL	TAPE WIDTH	DIAMETER	PIECES/REEL				
WFC0402	Embossed paper tape	178 mm / 7"	10 000				
WFC0603, WFC0805, WFC1206	Embossed paper tape	178 mm / 7"	5000				

#### Note

٠ Embossed carrier tape per EIA (EIAJ)

### PAPER TAPE SPECIFICATIONS



ТҮРЕ	RESISTANCE	CARRIER DIMENSIONS (in millimeters)									
TIFE	RANGE	Α	В	E	F	w	P0	P1	P2	D0	Т
WFC0402	3 m $\Omega$ to 50 m $\Omega$	$0.7 \pm 0.05$	1.2 ± 0.05	1.75 ± 0.1	$3.5 \pm 0.05$	8.0 ± 0.2	$4.0 \pm 0.1$	$2.0 \pm 0.1$	$2.0 \pm 0.05$	1.55 ± 0.05	$0.6 \pm 0.1$
WFC0603	1 m $\Omega$ to 5 m $\Omega$	1.4 ± 0.1	$1.9 \pm 0.1$	1.75 ± 0.1	$3.5 \pm 0.05$	8.0 ± 0.2	$4.0 \pm 0.1$	$4.0 \pm 0.1$	$2.0 \pm 0.05$	1.55 ± 0.05	0.75 ± 0.1
WFC0603	5.1 m $\Omega$ to 30 m $\Omega$	1.1 ± 0.1	$1.9 \pm 0.1$	1.75 ± 0.1	$3.5 \pm 0.05$	8.0 ± 0.2	4.0 ± 0.1	4.0 ± 0.1	$2.0 \pm 0.05$	1.55 ± 0.05	0.70 ± 0.1
WFC0805	1 m $\Omega$ to 5 m $\Omega$	$2.4 \pm 0.1$	$1.9 \pm 0.1$	1.75 ± 0.1	$3.5 \pm 0.05$	8.0 ± 0.2	$4.0 \pm 0.1$	$4.0 \pm 0.1$	$2.0 \pm 0.05$	1.55 ± 0.05	0.75 ± 0.1
WFC0805	5.1 m $\Omega$ to 40 m $\Omega$	1.6 ± 0.1	$2.4 \pm 0.1$	1.75 ± 0.1	$3.5 \pm 0.05$	8.0 ± 0.2	$4.0 \pm 0.1$	$4.0 \pm 0.1$	$2.0 \pm 0.05$	1.55 ± 0.05	0.97 ± 0.1
WFC1206	1 m $\Omega$ to 3 m $\Omega$	$2.0 \pm 0.1$	$3.6 \pm 0.1$	1.75 ± 0.1	$3.5 \pm 0.05$	8.0 ± 0.2	4.0 ± 0.1	4.0 ± 0.1	$2.0 \pm 0.05$	1.55 ± 0.05	0.87 ± 0.1
WFC1206	3.1 m $\Omega$ to 180 m $\Omega$	$2.0 \pm 0.1$	$3.6 \pm 0.1$	1.75 ± 0.1	$3.5 \pm 0.05$	8.0 ± 0.2	$4.0 \pm 0.1$	$4.0 \pm 0.1$	$2.0 \pm 0.05$	$1.55 \pm 0.05$	$0.97 \pm 0.1$

#### Notes

Embossed carrier tape per EIA (EIAJ)

Additional packaging details at www.vishay.com/doc?20051

Revision: 26-Aug-2022

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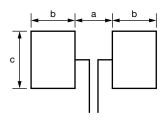
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### **STORAGE CONDITIONS**

Temperature: 5 °C to 35 °C, humidity: 40 % to 75 %

### **RECOMMENDED SOLDER PAD LAYOUT**



ТҮРЕ	PAD LAYOUT DIMENSIONS (in millimeters)						
TIFE	а	b	C				
0402 (7.1 mΩ to 50 mΩ)	0.50	0.50	0.60				
0402 (3 mΩ to 7 mΩ)	0.30	0.60	0.60				
0603 (9.1 mΩ to 30 mΩ)	0.90	0.70	1.00				
0603 (5 mΩ to 9 mΩ)	0.60	0.90	1.00				
0805 (1 mΩ to 5 mΩ)	0.80	1.60	1.45				
0805 (5.1 mΩ to 40 mΩ)	1.20	1.20	1.40				
1206 (1 mΩ to 3 mΩ)	0.40	1.80	2.20				
1206 (3.1 mΩ to 180 mΩ)	2.20	1.30	1.80				

Note

• Recommend to use the steel plate which thickness > 100 µm to avoid the insufficient solder height

### SOLDERING RECOMMENDATIONS

- Peak reflow temperatures and durations:
- IR reflow peak = 260 °C max. for 10 s
- Wave solder = 260 °C max. for 10 s
- Compatible with lead and lead (Pb)-free solder reflow processes
- Recommended IR reflow profile for surface mount devices: <u>www.vishay.com/doc?31052</u>



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